



#15/Response

PATENT

10/22/02

Shm H

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Jiang et al.

Serial No.: 09/483,712

Filed: January 14, 2000

For: CHIP-SCALE PACKAGES
HAVING ENCAPSULATED
CARRIER BONDS (as amended)

Examiner: M. Warren

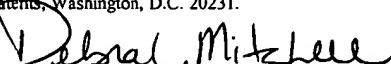
Group Art Unit: 2815

Attorney Docket No.: 3815.1US (98-0670)

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RESPONSE

Box NON FEE – AMENDMENT
Commissioner for Patents
Washington, D.C. 20231

Sir:

The following remarks are filed in response to the Examiner's remarks in the Office Action mailed July 2, 2002, the three-month shortened statutory period for response to which expires on October 2, 2002.